

SH0R3D42

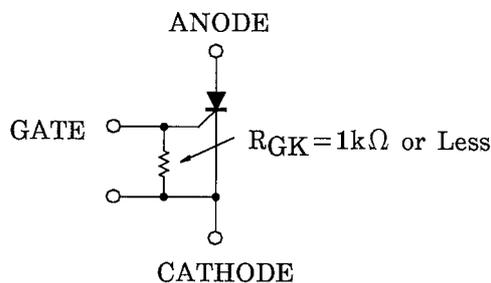
HIGH SPEED SWITCHING AND CONTROL APPLICATIONS

- Repetitive Peak Off-State Voltage : $V_{DRM} = 200V$
- Average On-State Current : $I_T (AV) = 300mA$
- Plastic Mold Type.

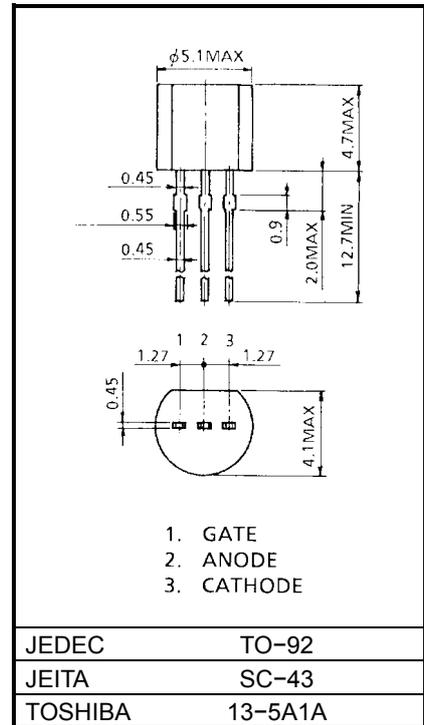
MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Off-State Voltage ($R_{GK} = 1k\Omega$)	V_{DRM}	200	V
Non-Repetitive Peak Off-State Voltage ($R_{GK} = 1k\Omega$)	V_{DSM}	250	V
Average On-State Current (Half Sine Waveform $T_a = 30^\circ C$)	$I_T (AV)$	300	mA
R.M.S On-State Current	$I_T (RMS)$	450	mA
Peak One Cycle Surge On-State Current (Non-Repetitive)	I_{TSM}	7 (50Hz)	A
I^2t Limit Value	I^2t	0.3	A^2s
Peak Gate Power Dissipation	P_{GM}	0.1	W
Average Gate Power Dissipation	$P_G (AV)$	0.01	W
Peak Forward Gate Voltage	V_{FGM}	3.5	V
Peak Reverse Gate Voltage	V_{RGM}	-7	V
Peak Forward Gate Current	I_{GM}	125	mA
Junction Temperature	T_j	-40~125	$^\circ C$
Storage Temperature Range	T_{stg}	-40~125	$^\circ C$

Note: Should be used with gate resistance as follows.



Unit: mm

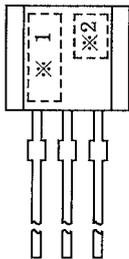


Weight: 0.2g

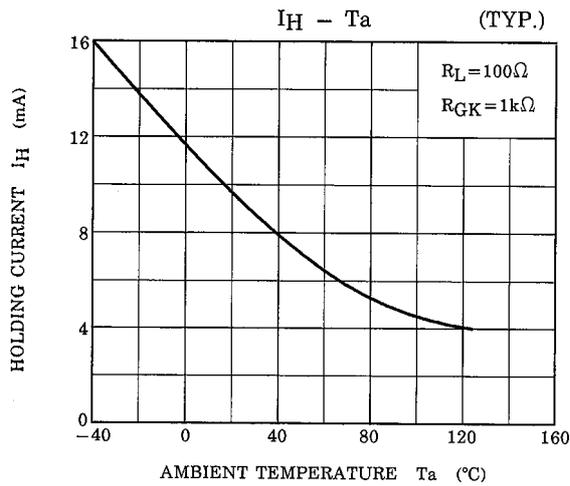
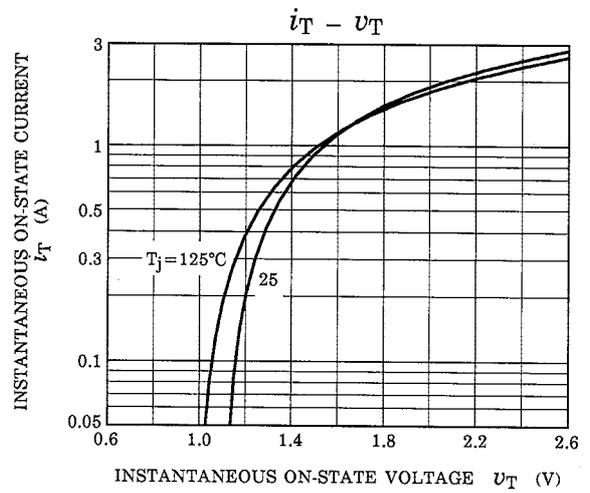
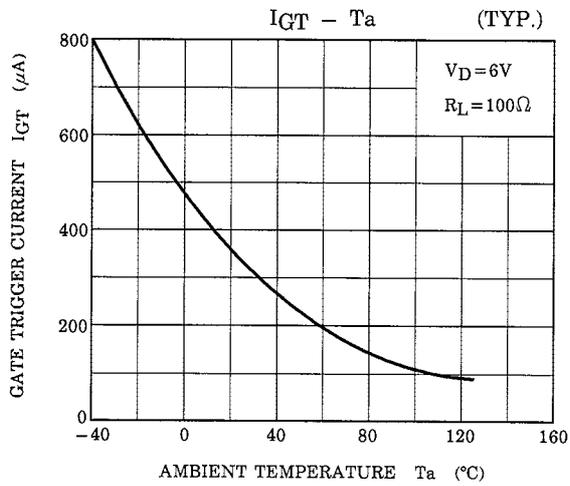
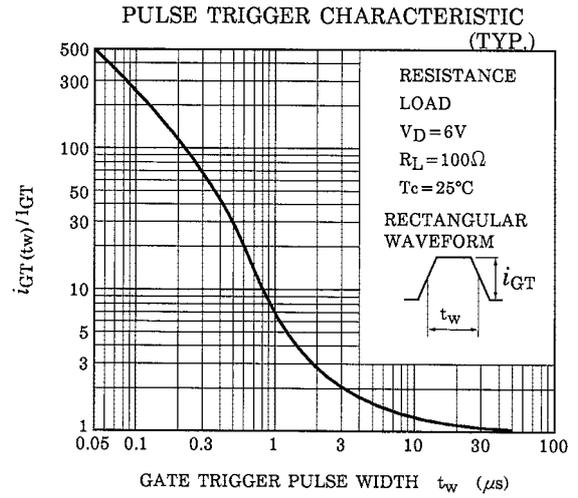
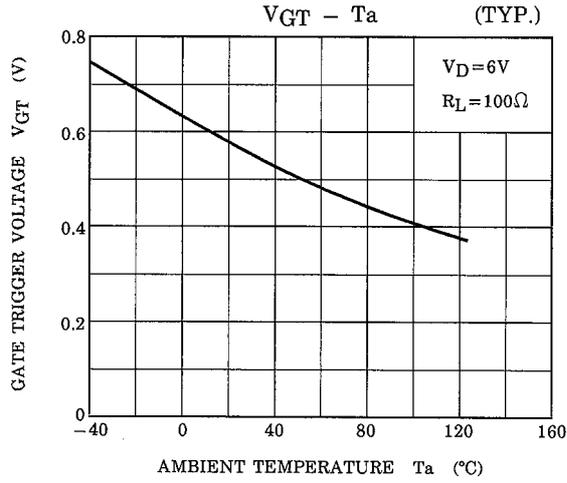
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	MAX	UNIT
Repetitive Peak Off-State Current and Peak Reverse Current	I_{DRM}	$T_j = 125^\circ\text{C}$, $V_{DRM} = \text{Rated}$ $R_{GK} = 1\text{k}\Omega$	—	100	μA
Peak On-State Voltage	V_{TM}	$I_{TM} = 2\text{A}$	—	1.8	V
Gate Trigger Voltage	V_{GT}	$V_D = 6\text{V}$, $R_L = 100\Omega$	—	0.9	V
Gate Trigger Current	I_{GT}		—	1.0	mA
Gate Non-Trigger Voltage	V_{GD}	$V_D = \text{Rated}$, $T_c = 110^\circ\text{C}$	0.3	—	V
Turn-On Time	t_{gt}	$V_D = \text{Rated}$, $I_{TM} = 4\text{A}$ $I_G = 10\text{mA}$	—	2.0	μs
Turn-Off Time	t_q	$V_D = 20\text{V}$, $I_P = 1\text{A}$, $R_{GK} = 1\text{k}\Omega$	—	6.0	μs
Critical Rate of Rise of Off-State Voltage	dv / dt	$V_D = \text{Rated}$, $R_{GK} = 1\text{k}\Omega$ $T_c = 110^\circ\text{C}$, Exponential Rise	15	—	V / μs
Holding Current	I_H	$R_L = 100\Omega$, $R_{GK} = 1\text{k}\Omega$	—	15	mA
Thermal Resistance	$R_{th(j-c)}$	Junction to Ambient	—	250	$^\circ\text{C} / \text{W}$

MARKING



NUMBER	SYMBOL		MARK
*1	TYPE	SH0R3D42	H0R3D
*2	Lot Number Month (Starting from Alphabet A) Year (Last Decimal Digit of the Current Year)		Example 8A : January 1998 8B : February 1998 8L : December 1998



RESTRICTIONS ON PRODUCT USE

000707EAA

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.